

DELPHI SERIES



FEATURES

- ♦ High efficiency: 93% @12V/13A
- ♦ Size:
 - 58.4mm x 22.8mm x 9.5mm (2.30"x0.90"x0.37") w/o heat-spreader
 - 58.4mm x 22.8mm x 12.7mm (2.30"x0.90"x0.5") with heat-spreader
- ♦ Industry standard pin out
- ♦ Fixed frequency operation
- ♦ Input UVLO, Output OTP, OCP, OVP
- ♦ Monotonic startup into normal and Pre-biased loads
- ♦ 2250V Isolation and basic insulation
- ♦ No minimum load required
- ♦ SMD and through-hole versions
- ♦ No negative current during power or enable on/off
- ♦ ISO 9001, TL 9000, ISO 14001, QS 9000, OHSAS 18001 certified manufacturing facility
- ♦ UL/cUL 60950 (US & Canada) recognized, and TUV (EN60950) certified
- ♦ CE mark meets 73/23/EEC and 93/68/EEC directive

Delphi Series E48SH, 150W Eighth Brick Family DC/DC Power Modules: 48V in, 12V/13A out

The Delphi Series E48SH Eighth Brick, 48V input, single output, isolated DC/DC converters are the latest offering from a world leader in power systems technology and manufacturing — Delta Electronics, Inc. This product family is available in either a through-hole or surface-mounted package and provides up to 150 watts of power or 50A of output current (1.2V and below) in an industry standard footprint and pinout. The E48SH converter operates from an input voltage of 36V to 75V and is available in output voltages from 1.0V to 15V. Efficiency is 93% for the 12V output at full load. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performance, as well as extremely high reliability under highly stressful operating conditions. All models are fully protected from abnormal input/output voltage, current, and temperature conditions. The Delphi Series converters meet all safety requirements with basic insulation.

OPTIONS

- ♦ Positive On/Off logic
- ♦ Short pin lengths available
- ♦ External Synchronization
- ♦ Output OVP latch mode
- ♦ Through hole pins with Heat spreader

APPLICATIONS

- ♦ Telecom/DataCom
- ♦ Wireless Networks
- ♦ Optical Network Equipment
- ♦ Server and Data Storage
- ♦ Industrial/Test Equipment

TECHNICAL SPECIFICATIONS

(T_A=25°C, airflow rate=300 LFM, V_{in}=48Vdc, nominal V_{out} unless otherwise noted.)

PARAMETER	NOTES and CONDITIONS	E48SH12013 (Standard)			
		Min.	Typ.	Max.	Units
ABSOLUTE MAXIMUM RATINGS					
Input Voltage					
Continuous				80	Vdc
Transient (100ms)	100ms			100	Vdc
Operating Ambient Temperature		-40		85	°C
Storage Temperature		-55		125	°C
Input/Output Isolation Voltage				2250	Vdc
INPUT CHARACTERISTICS					
Operating Input Voltage		36		75	Vdc
Input Under-Voltage Lockout					
Turn-On Voltage Threshold		33	34	35	Vdc
Turn-Off Voltage Threshold		31	32	33	Vdc
Lockout Hysteresis Voltage		1	2	3	Vdc
Maximum Input Current	100% Load, 36Vin			4.8	A
No-Load Input Current				100	mA
Off Converter Input Current			3	10	mA
Inrush Current(I ⁺ t)				1	A ² s
Input Reflected-Ripple Current	P-P thru 12μH inductor, 5Hz to 20MHz		20		mA
Input Voltage Ripple Rejection	120 Hz		60		dB
OUTPUT CHARACTERISTICS					
Output Voltage Set Point	Vin=48V, Io=Io.max, Tc=25°C	11.88	12.00	12.12	Vdc
Output Voltage Regulation					
Over Load	Io=Io,min to Io,max		±10	±20	mV
Over Line	Vin=36V to 75V		±10	±20	mV
Over Temperature	Tc=-40°C to 115°C		±50		mV
Total Output Voltage Range	over sample load, line and temperature	11.76		12.24	V
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth				
Peak-to-Peak	Full Load, 1μF ceramic, 10μF tantalum		40	80	mV
RMS	Full Load, 1μF ceramic, 10μF tantalum		10	20	mV
Operating Output Current Range		0		13	A
Output DC Current-Limit Inception	Output Voltage 10% Low	110		140	%
DYNAMIC CHARACTERISTICS					
Output Voltage Current Transient	48V, 10μF Tan & 1μF Ceramic load cap, 0.1A/μs				
Positive Step Change in Output Current	50% Io.max to 75% Io.max		110	200	mV
Negative Step Change in Output Current	75% Io.max to 50% Io.max		110	200	mV
Settling Time (within 1% Vout nominal)			100		us
Turn-On Transient					
Start-Up Time, From On/Off Control			15	25	ms
Start-Up Time, From Input			20	30	ms
Maximum Output Capacitance	Full load; no overshoot of Vout at startup			5000	μF
EFFICIENCY					
100% Load		92.5	93.5		%
60% Load		93	94		%
ISOLATION CHARACTERISTICS					
Input to Output				2250	Vdc
Isolation Resistance				10	MΩ
Isolation Capacitance			1500		pF
FEATURE CHARACTERISTICS					
Switching Frequency		185	200	225	kHz
ON/OFF Control, Negative Remote On/Off logic					
Logic Low (Module On)	Von/off at Ion/off=1.0mA			1.2	V
Logic High (Module Off)	Von/off at Ion/off=0.0 μA	3		50	V
ON/OFF Control, Positive Remote On/Off logic					
Logic Low (Module Off)	Von/off at Ion/off=1.0mA			1.2	V
Logic High (Module On)	Von/off at Ion/off=0.0 μA	3		50	V
ON/OFF Current (for both remote on/off logic)	Ion/off at Von/off=0.0V			1	mA
Leakage Current (for both remote on/off logic)	Logic High, Von/off=15V			50	uA
Output Voltage Trim Range	Pout ≤ max rated power, trim up curve refer to figure4	-20		10	%
Output Voltage Remote Sense Range	Pout ≤ max rated power, refer to figure4			10	%
Output Over-Voltage Protection	Over full temp range; % of nominal Vout	13.8		16.2	V
GENERAL SPECIFICATIONS					
MTBF	Io=80% of Io, max; 300LFM @25C		2.2		M hours
Weight	Without heat spreader		25		grams
Weight	With heat spreader		36.6		grams
Over-Temperature Shutdown (Without heat spreader)	Refer to Figure 22 for Hot spot 1 location (48Vin,80% Io, 200LFM,Airflow from Vin- to Vin+)		130		°C
Over-Temperature Shutdown (With heat spreader)	Refer to Figure 24 for Hot spot 2 location (48Vin,80% Io, 200LFM,Airflow from Vin- to Vin+)		118		°C
Over-Temperature Shutdown (NTC resistor)			125		°C
Note: Please attach thermocouple on NTC resistor to test OTP function, the hot spots' temperature is just for reference.					

Note: Please attach thermocouple on NTC resistor to test OTP function, the hot spots' temperature is just for reference.



ELECTRICAL CHARACTERISTICS CURVES

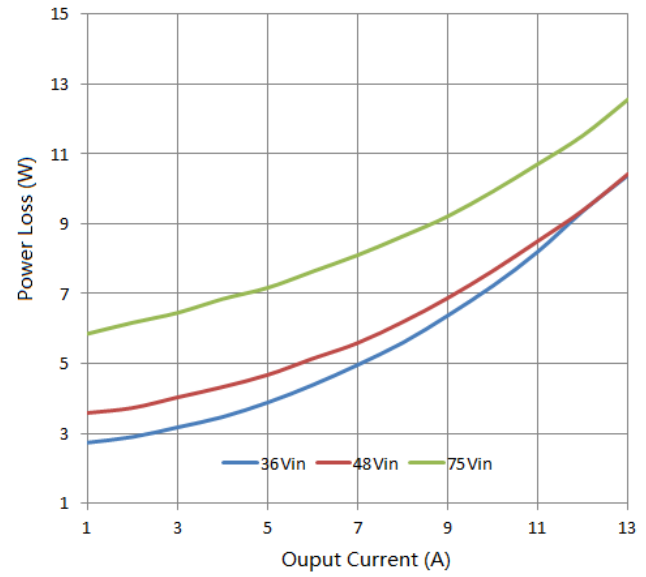
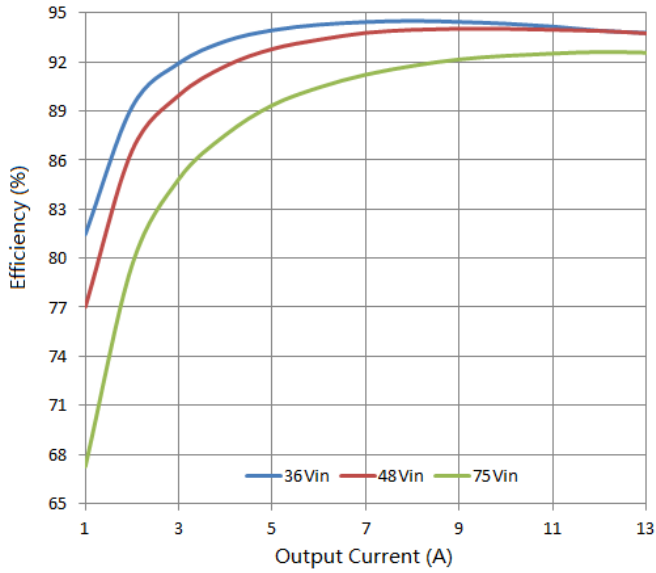


Figure 1: Efficiency vs. load current for minimum, nominal, and maximum input voltage at 25°C

Figure 2: Power dissipation vs. load current for minimum, nominal, and maximum input voltage at 25°C.

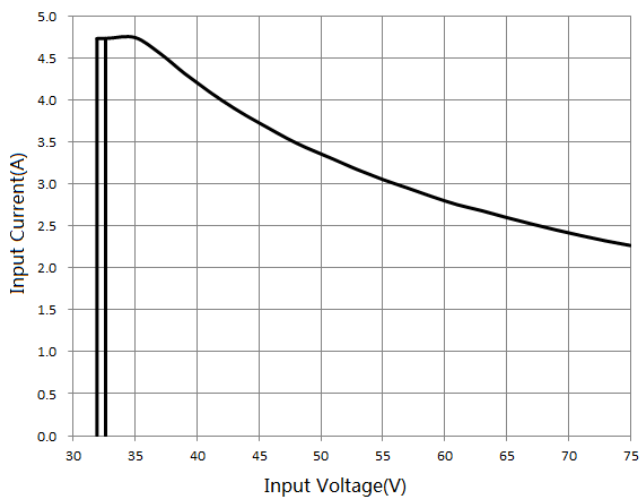


Figure 3: Typical full load input characteristics at room temperature

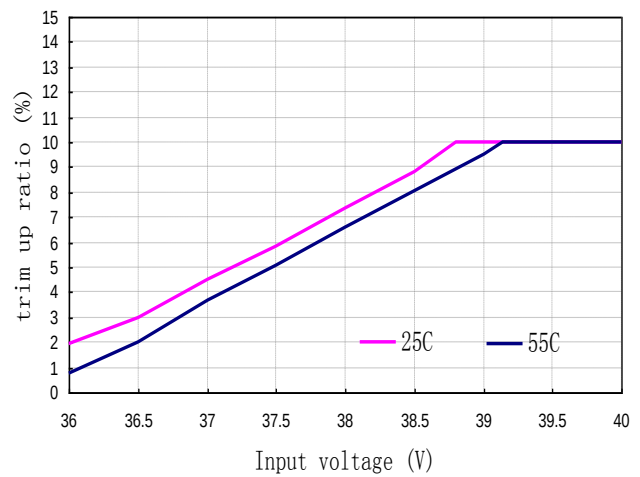


Figure 4: trim up curve at full load, 200LFM, 25°C and 200LFM, 55°C



ELECTRICAL CHARACTERISTICS CURVES

For Negative Remote On/Off Logic

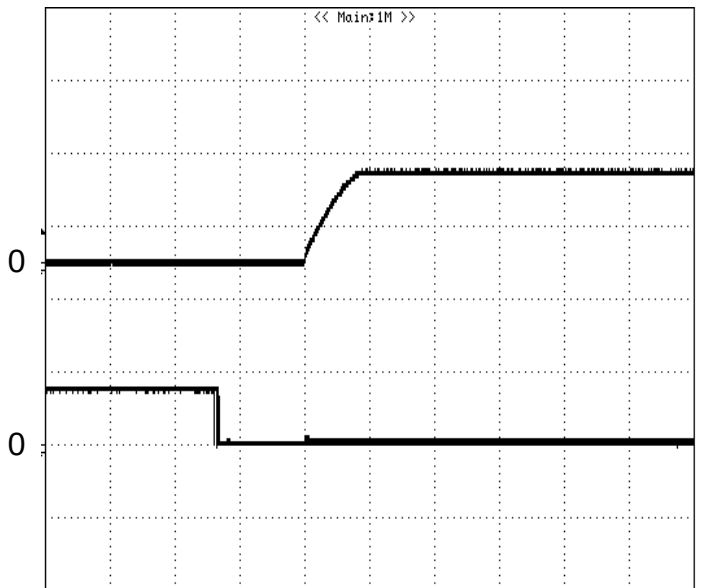


Figure 5: Turn-on transient at zero load current (5 ms/div). Vin=48V.Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF input, 5V/div

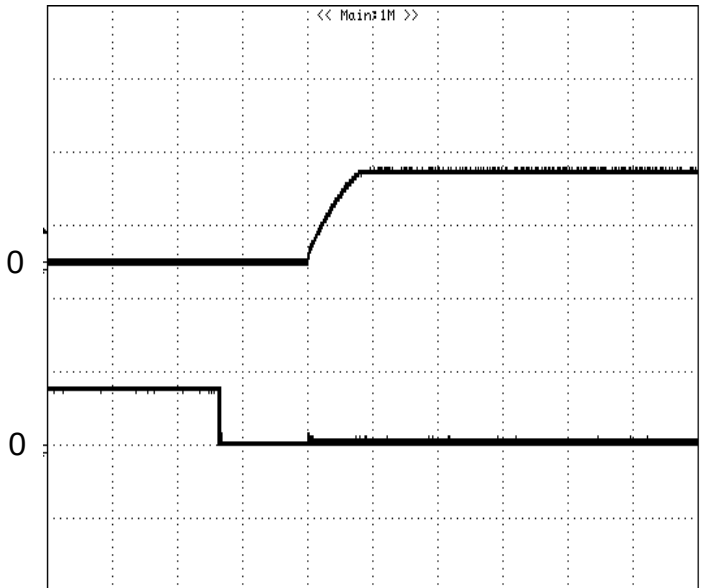


Figure 6: Turn-on transient at full rated load current (constant current load) (5 ms/div). Vin=48V.Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF input, 5V/div

For Input Voltage Start up

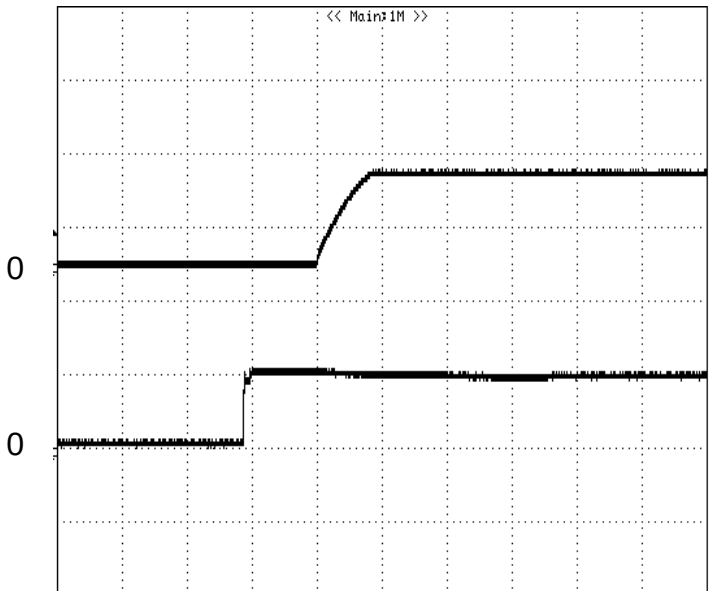


Figure 7: Turn-on transient at zero load current (5 ms/div). Vin=48V.Top Trace: Vout, 10V/div, Bottom Trace: input voltage, 50V/div

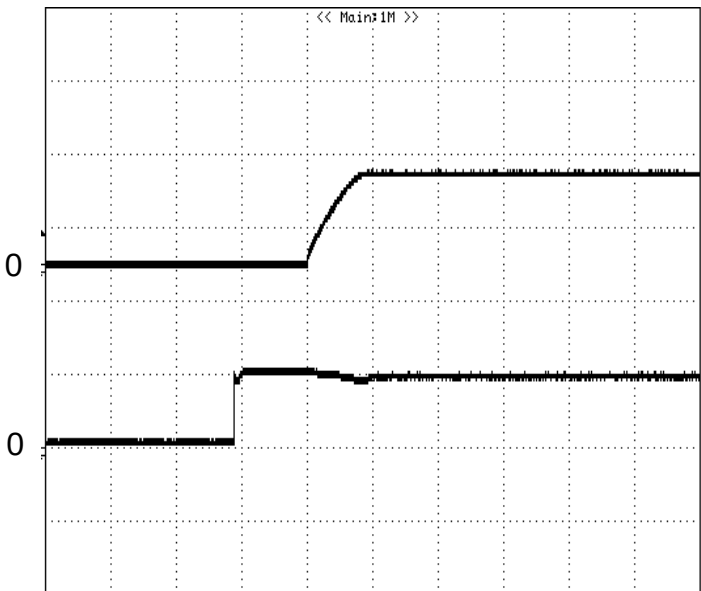


Figure 8: Turn-on transient at full rated load current (constant current load) (5 ms/div). Vin=48V.Top Trace: Vout, 10V/div; Bottom Trace: input voltage, 50V/div



ELECTRICAL CHARACTERISTICS CURVES

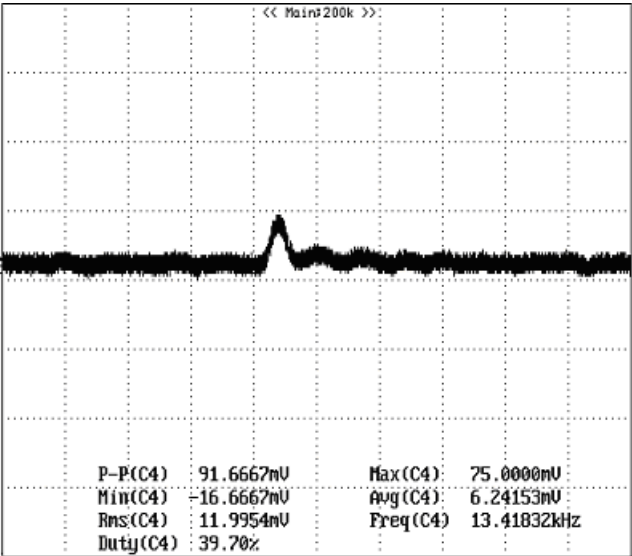


Figure 9: Output voltage response to step-change in load current (75%-50% of I_o , max; $di/dt = 0.1A/\mu s$). Load cap: $10\mu F$, tantalum capacitor and $1\mu F$ ceramic capacitor. Trace: V_{out} (50mV/div, 100us/div), Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module..

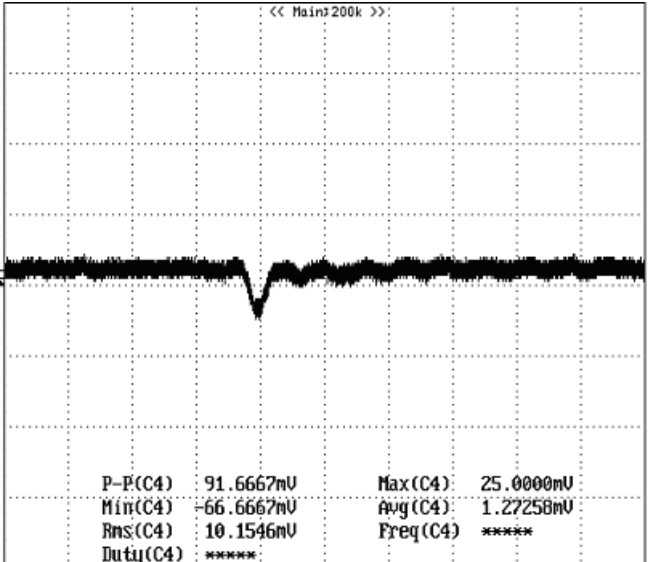


Figure 10: Output voltage response to step-change in load current (50%-75% of I_o , max; $di/dt = 0.1A/\mu s$). Load cap: $10\mu F$, tantalum capacitor and $1\mu F$ ceramic capacitor. Trace: V_{out} (50mV/div, 100us/div), Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module..

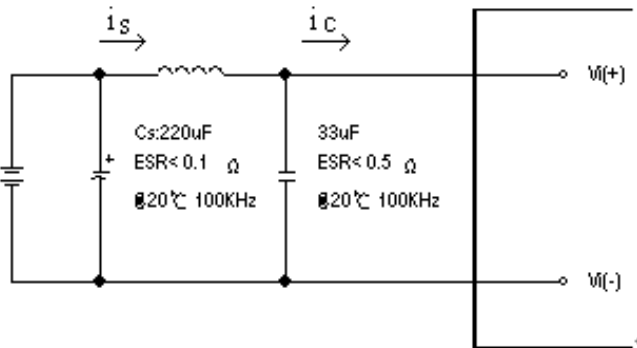


Figure 11: Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.
Note: Measured input reflected-ripple current with a simulated source Inductance (L_{TEST}) of $12\mu H$. Capacitor C_s offset possible battery impedance. Measure current as shown above

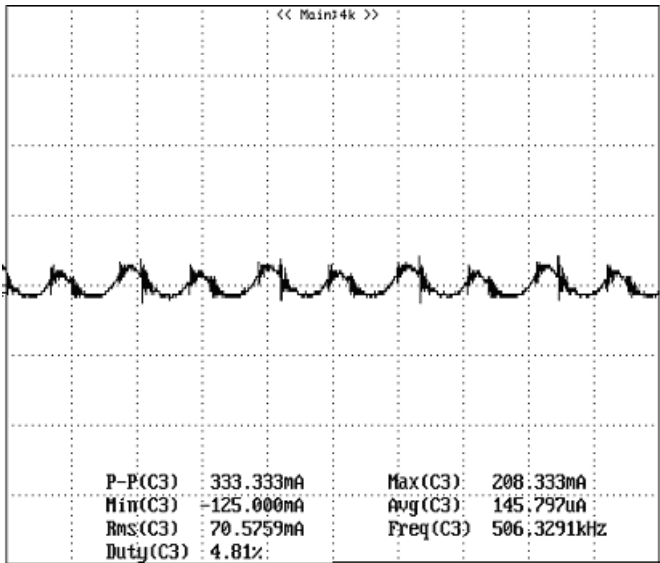


Figure 12: Input Terminal Ripple Current, i_c , at full rated output current and nominal input voltage with $12\mu H$ source impedance and $33\mu F$ electrolytic capacitor (500 mA/div, 2us/div).

ELECTRICAL CHARACTERISTICS CURVES

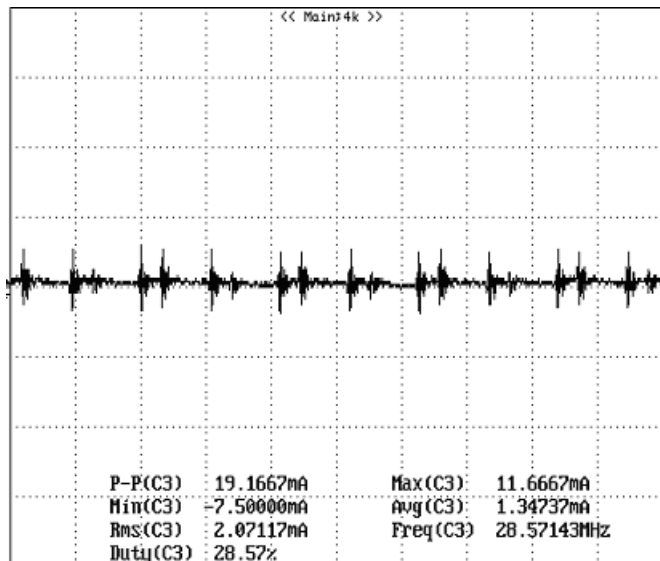


Figure 13: Input reflected ripple current, i_s , through a 12 μ H source inductor at nominal input voltage and rated load current (20 mA/div, 20 ns/div).

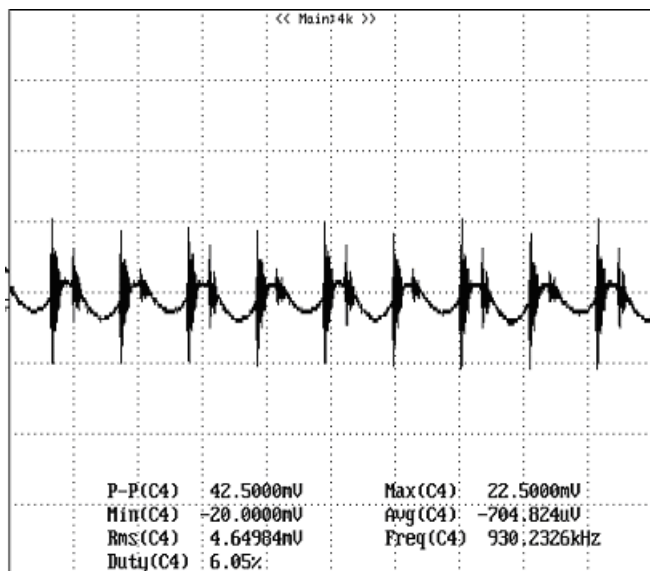


Figure 15: Output voltage ripple at nominal input voltage and rated load current ($I_o=10A$) (20 mV/div, 20 ns/div)
Load capacitance: 1 μ F ceramic capacitor and 10 μ F tantalum capacitor. Bandwidth: 20 MHz. Scope measurements should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module.

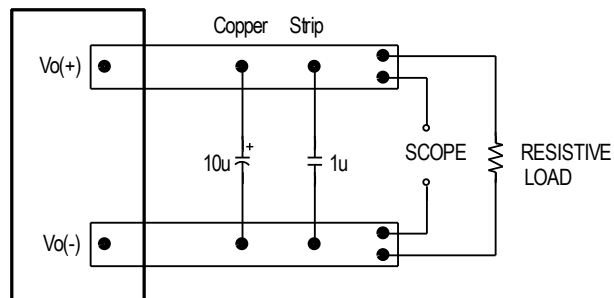


Figure 14: Output voltage noise and ripple measurement test setup

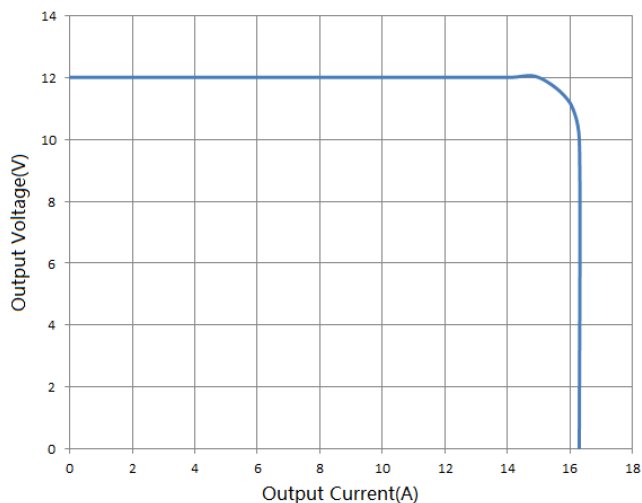


Figure 16: Output voltage vs. load current showing typical current limit curves and converter shutdown points.

DESIGN CONSIDERATIONS

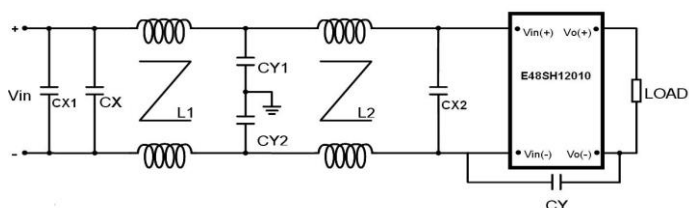
Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few μH , we advise adding a 10 to 100 μF electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the input of the module to improve the stability.

Layout and EMC Considerations

Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Below is the reference design for an input filter tested with E48SH12013XXX to meet class B in CISPR 22.

Schematic and Components List



Cx1: 100V/2.2 μF * 2 MLCC, Cx=4.7 μF MLCC

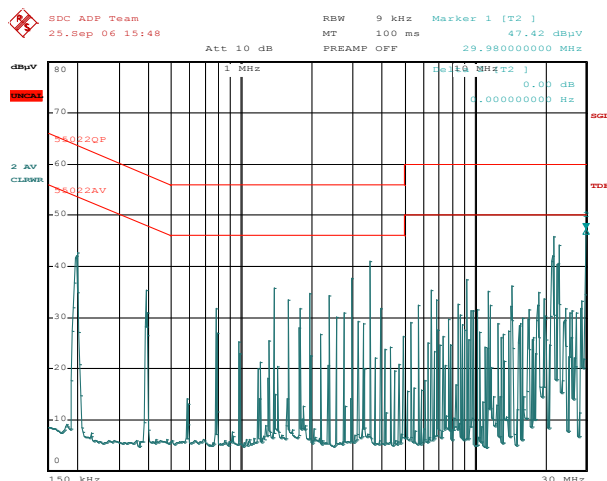
Cx2: 100V/2.2 μF MLCC+ 100V/100 μF Al cap

Cy: 3000V/3.9nF * 2 MLCC, Cy1=Cy2=4.7nF MLCC

L1=0.08mH, L2= 0.85mH

L1 leakage=0.5 μH , L2 leakage=4 μH

Test Result: Vin=48V, Io=13A,



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Safety Considerations

The power module must be installed in compliance with the spacing and separation requirements of the end-user's safety agency standard, i.e., UL60950, CAN/CSA-C22.2 No. 60950-00 and EN60950: 2000 and IEC60950-1999, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- If the metal baseplate is grounded, one Vi pin and one Vo pin shall also be grounded.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a normal-blow fuse with 20A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

FEATURES DESCRIPTIONS

Over-Current Protection

The E48SH modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. When the output current exceeds the OCP set point, the current limit function will work by initially reduce duty cycle of the module, the unit will go out of regulation but remains in safe operating area before the output drops below 50%. When output drops below 50%, the modules will automatically shut down and enter hiccup mode.

During hiccup, the modules will try to restart after shutdown. If the overload condition still exists, the module will shut down again. This restart trial will continue until the overload condition is corrected.

Over-Voltage Protection

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the module will shut down and restart after 200mS. latch off mode is optional. Under latch off mode the over-voltage latch is reset by either cycling the input power or by toggling the on/off signal for one second.

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down.

The module will try to restart after shutdown. If the over-temperature condition still exists during restart, the module will shut down again. This restart trial will continue until the temperature is within specification.

Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi(-) terminal. The switch can be an open collector or open drain.

For negative logic if the remote on/off feature is not used, please short the on/off pin to Vi(-). For positive logic if the remote on/off feature is not used, please leave the on/off pin to floating.

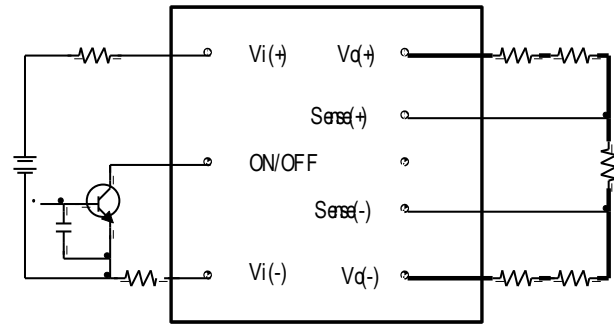


Figure 17: Remote on/off implementation

Remote Sense

Remote sense compensates for voltage drops on the output by sensing the actual output voltage at the point of load. The voltage between the remote sense pins and the output terminals must not exceed the output voltage sense range given here:

$$[Vo(+) - Vo(-)] - [SENSE(+) - SENSE(-)] \leq 10\% \times V_{out}$$

This limit includes any increase in voltage due to remote sense compensation and output voltage set point adjustment (trim).

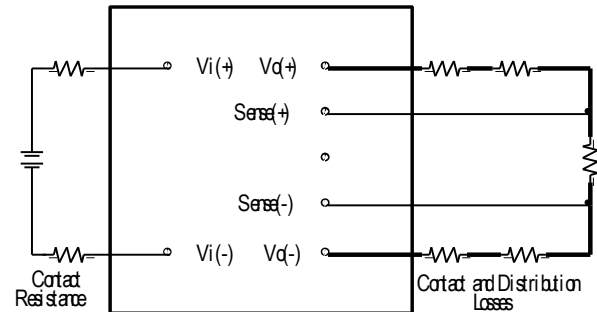


Figure 18: Effective circuit configuration for remote sense operation

If the remote sense feature is not used to regulate the output at the point of load, please connect SENSE(+) to Vo(+) and SENSE(-) to Vo(-) at the module.

The output voltage can be increased by both the remote sense and the trim; however, the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Care should be taken to ensure that the maximum output power does not exceed the maximum rated power.

FEATURES DESCRIPTIONS (CON.)

Output Voltage Adjustment (TRIM)

To increase or decrease the output voltage set point, the modules may be connected with an external resistor between the TRIM pin and either the SENSE(+) or SENSE(-). The TRIM pin should be left open if this feature is not used.

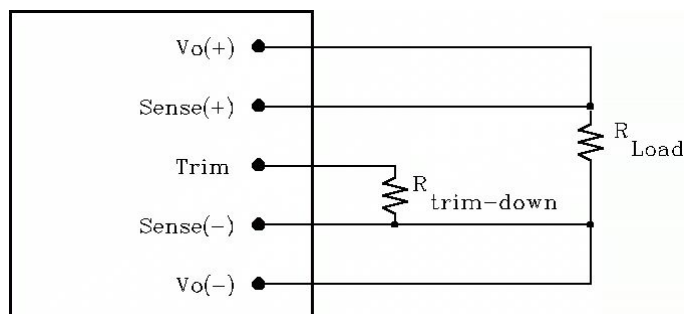


Figure 19: Circuit configuration for trim-down (decrease output voltage)

If the external resistor is connected between the TRIM and SENSE (-) pins, the output voltage set point decreases (Fig.19). The external resistor value required to obtain a percentage of output voltage change $\Delta\%$ is defined as:

$$R_{trim-down} = \frac{511}{\Delta} - 10.2 (K\Omega)$$

Ex. When Trim-down -10%(12V×0.9=10.8V)

$$R_{trim-down} = \frac{511}{10} - 10.2 = 40.9 (K\Omega)$$

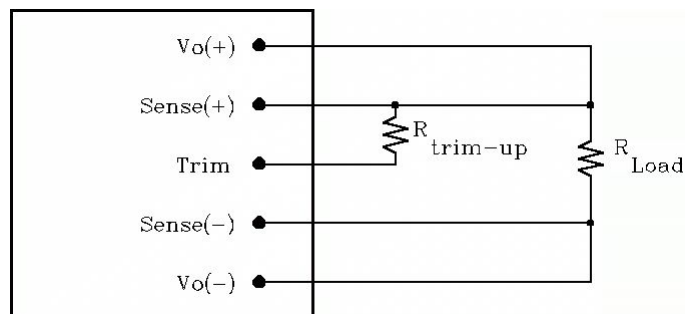


Figure 20: Circuit configuration for trim-up (increase output voltage)

If the external resistor is connected between the TRIM and SENSE (+) the output voltage set point increases (Fig. 20). The external resistor value required to obtain a percentage output voltage change $\Delta\%$ is defined as:

$$R_{trim-up} = \frac{5.11 \times V_o \times (100 + \Delta)}{1.225 \times \Delta} - \frac{511}{\Delta} - 10.22 (K\Omega)$$

Ex. When Trim-up +10%(12V×1.1=13.2V)

$$R_{trim-up} = \frac{5.11 \times 12 \times (100 + 10)}{1.225 \times 10} - \frac{511}{10} - 10.22 = 489.3 (K\Omega)$$

The output voltage can be increased by both the remote sense and the trim, however the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power.

THERMAL CONSIDERATIONS

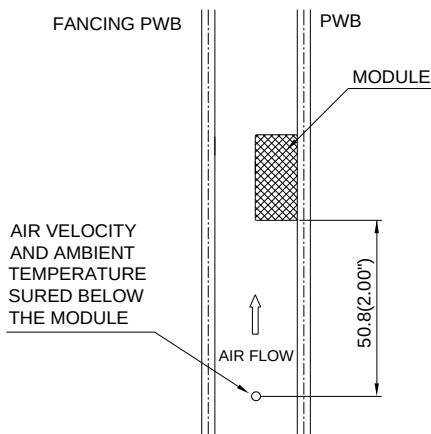
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a 185mmX185mm,105µm (30z),6 layers test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 21: Wind tunnel test setup

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability; the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.

THERMAL CURVES (WITHOUT HEAT SPREADER)

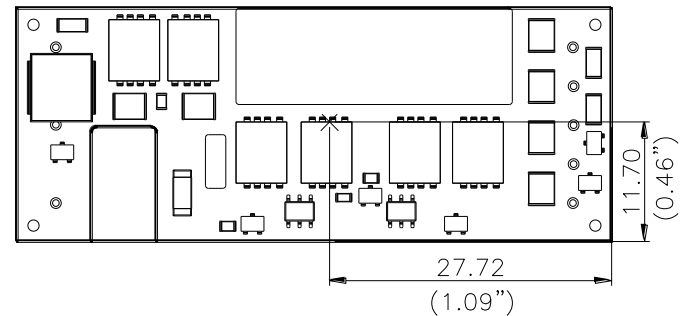


Figure 22: Hot spot 1's temperature measured point.

*The allowed maximum hot spot temperature is defined at 123 °C

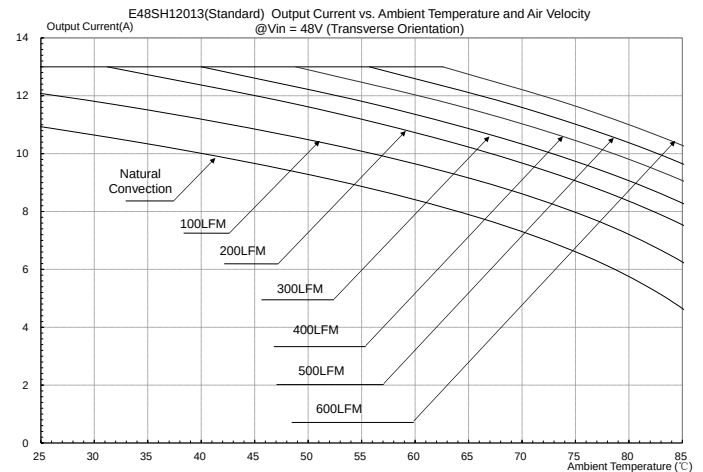


Figure 23: Output current vs. ambient temperature and air velocity @ $V_{in}=48V$ (Transverse Orientation, airflow from V_{in-} to V_{in+} , without heat spreader)

THERMAL CURVES (WITH HEAT SPREADER)

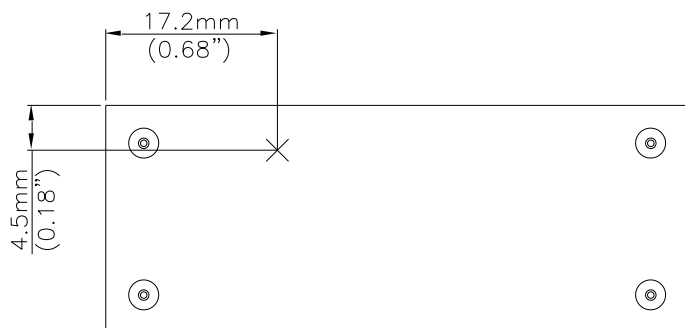


Figure 24: Hot spot 2's temperature measured point.

*The allowed maximum hot spot temperature is defined at 106 °C

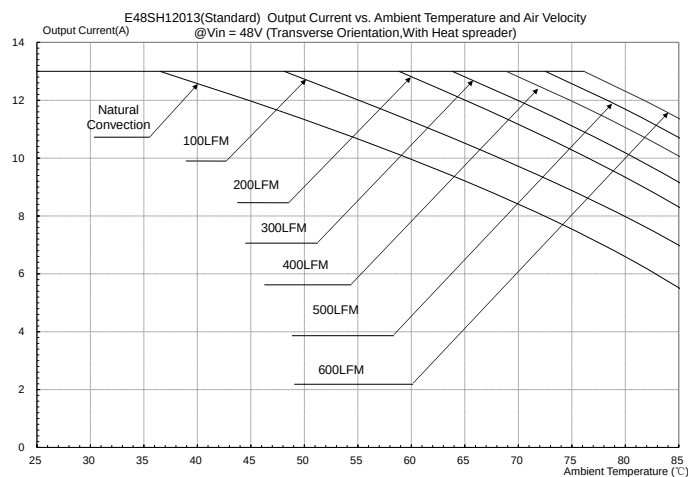
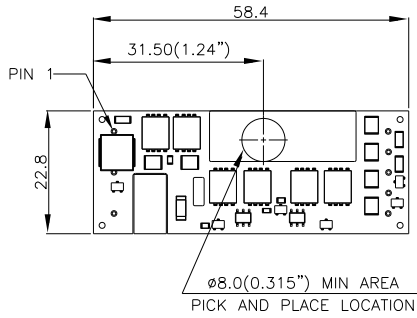


Figure 25: Output current vs. ambient temperature and air velocity
@ $V_{in}=48V$ (Transverse Orientation, airflow from V_{in-} to V_{in+} ,
with heat spreader)

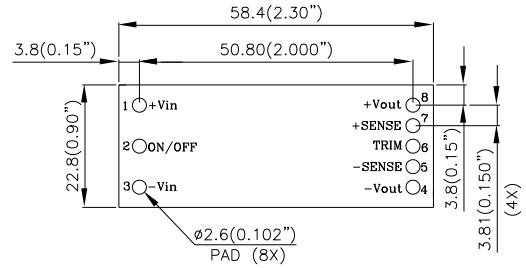


PICK AND PLACE LOCATION(SMD)



NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm $\pm$ 0.5mm(X.XX in. $\pm$ 0.02 in.)
X.XXmm $\pm$ 0.25mm(X.XXX in. $\pm$ 0.010 in.)

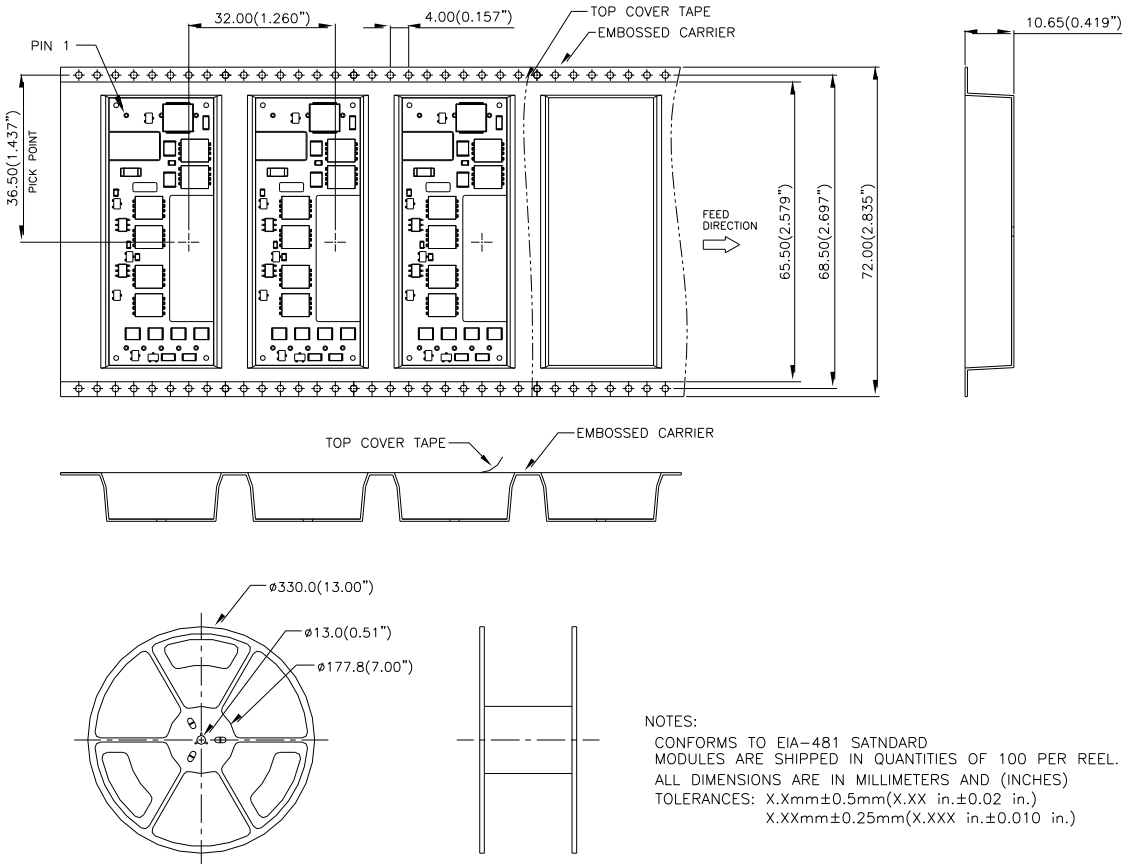
RECOMMENDED PAD LAYOUT (SMD)



RECOMENDED P.W.B. PAD LAYOUT

NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm $\pm$ 0.5mm(X.XX in. $\pm$ 0.02 in.)
X.XXmm $\pm$ 0.25mm(X.XXX in. $\pm$ 0.010 in.)

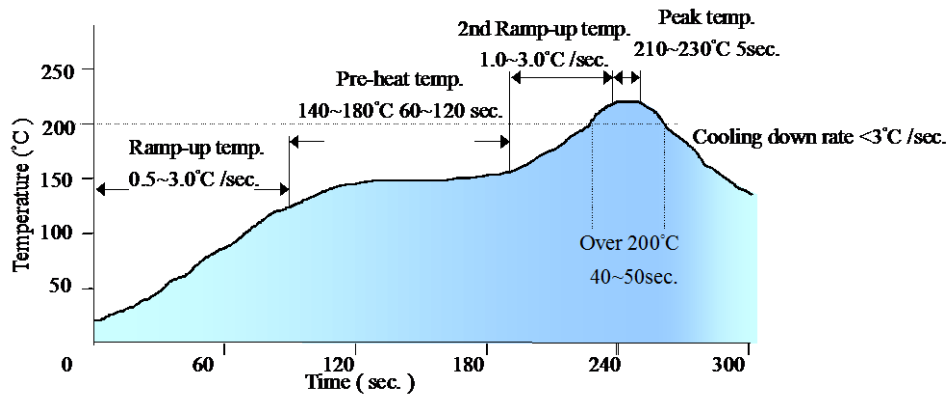
SURFACE-MOUNT TAPE & REEL



NOTES:
CONFORMS TO EIA-481 SATNDARD
MODULES ARE SHIPPED IN QUANTITIES OF 100 PER REEL.
ALL DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm $\pm$ 0.5mm(X.XX in. $\pm$ 0.02 in.)
X.XXmm $\pm$ 0.25mm(X.XXX in. $\pm$ 0.010 in.)

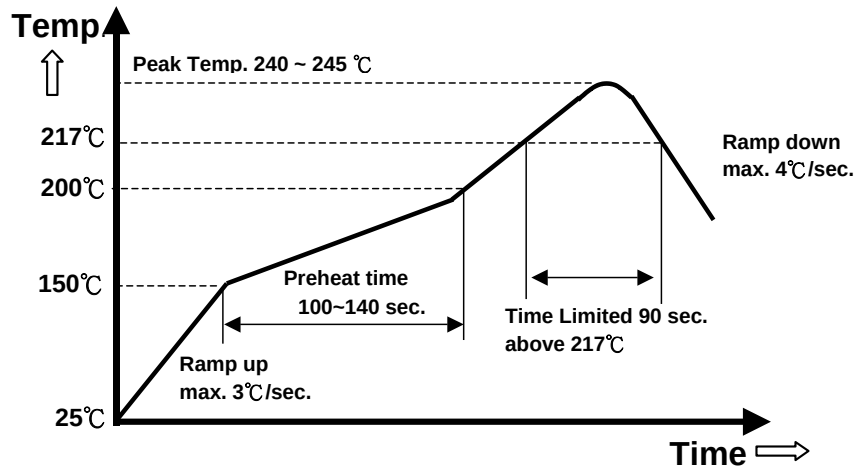


LEADED (Sn/Pb) PROCESS RECOMMEND TEMP. PROFILE(SMD)



Note: The temperature refers to the pin of E48SH, measured on the pin +Vout joint.

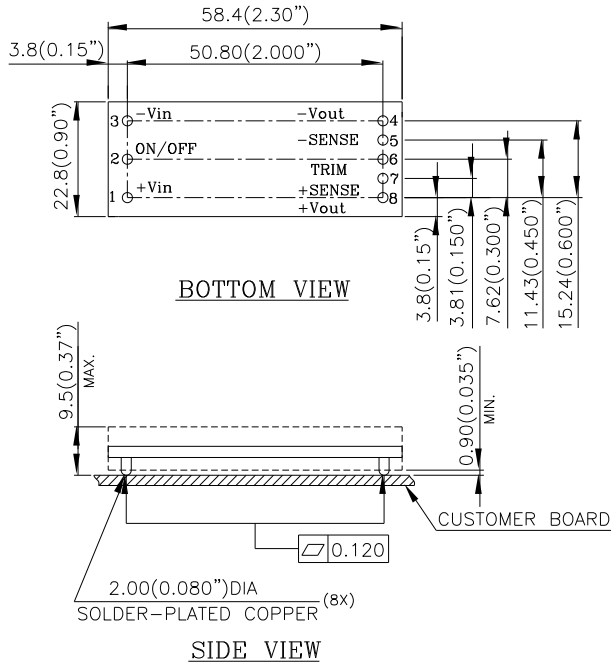
LEAD FREE (SAC) PROCESS RECOMMEND TEMP. PROFILE(SMD)



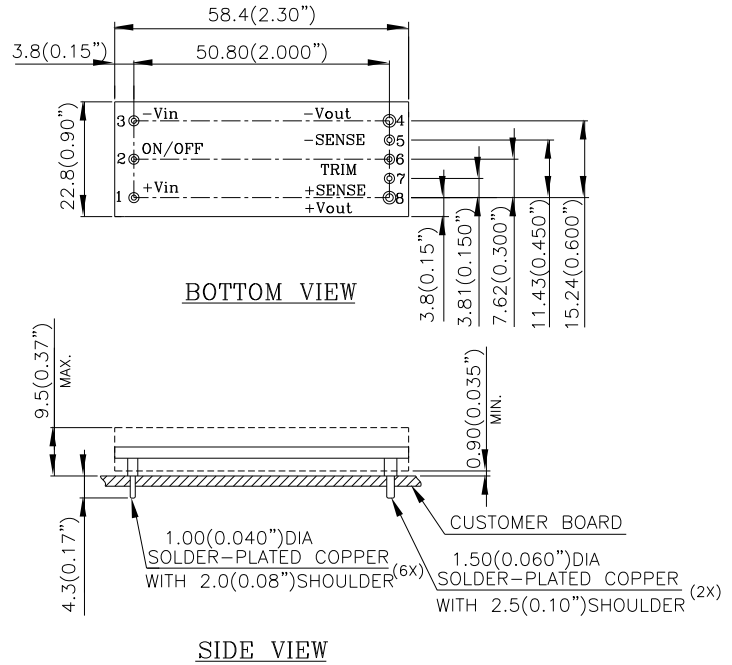
Note: The temperature refers to the pin of E48SH, measured on the pin +Vout joint.

MECHANICAL DRAWING (WITHOUT HEATSPREADER)

SURFACE-MOUNT MODULE



THROUGH-HOLE MODULE



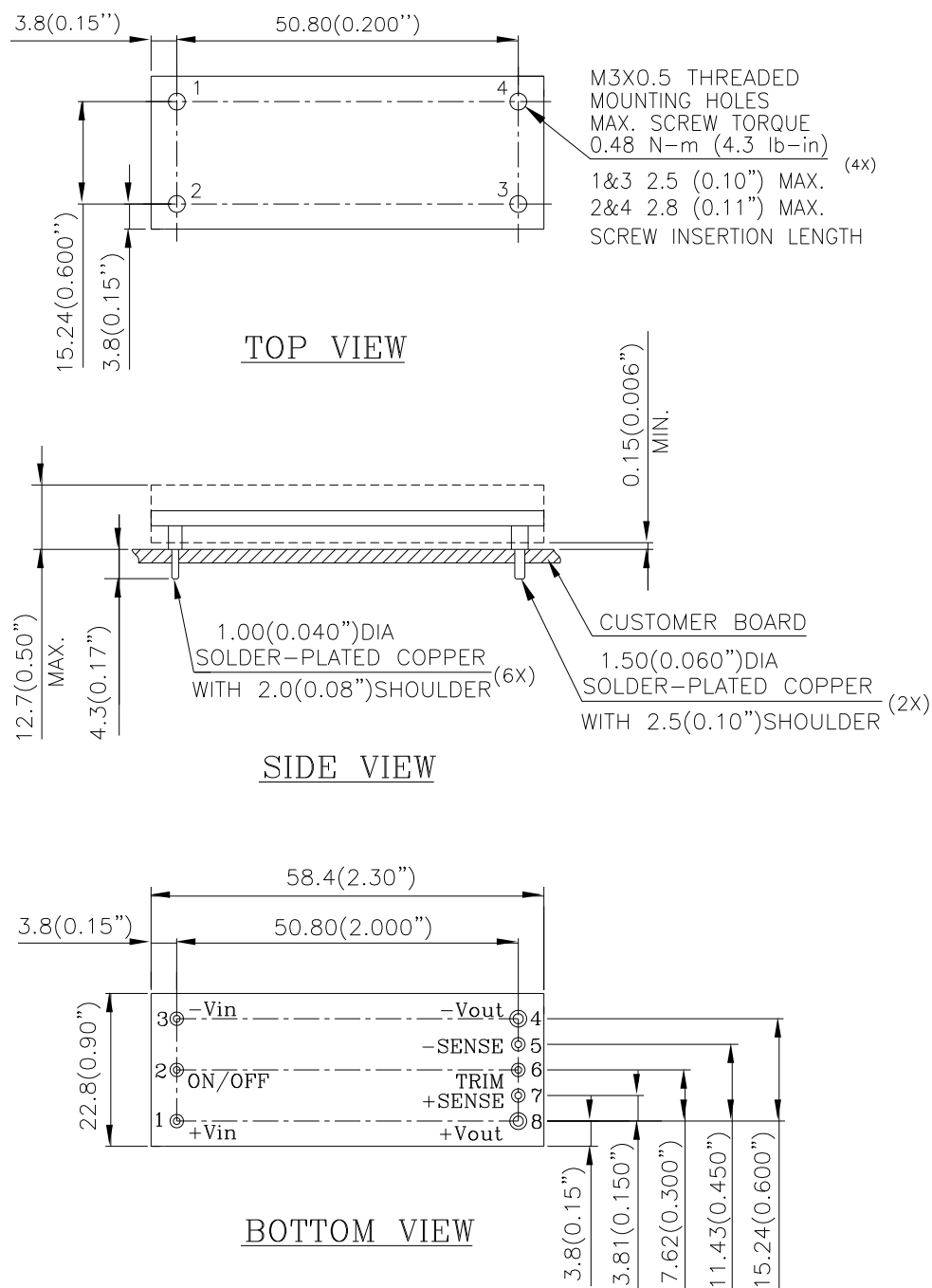
NOTES:
 DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
 TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
 X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Pin No.	Name	Function
1	+Vin	Positive input voltage
2	ON/OFF	Remote ON/OFF
3	-Vin	Negative input voltage
4	-Vout	Negative output voltage
5	-SENSE	Negative remote sense
6	TRIM	Output voltage trim
7	+SENSE	Positive remote sense
8	+Vout	Positive output voltage

Notes: All pins are copper alloy with matte tin plated over Nickel under-plating.

MECHANICAL DRAWING (WITH HEATSPREADER)

*** For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.**



NOTES:

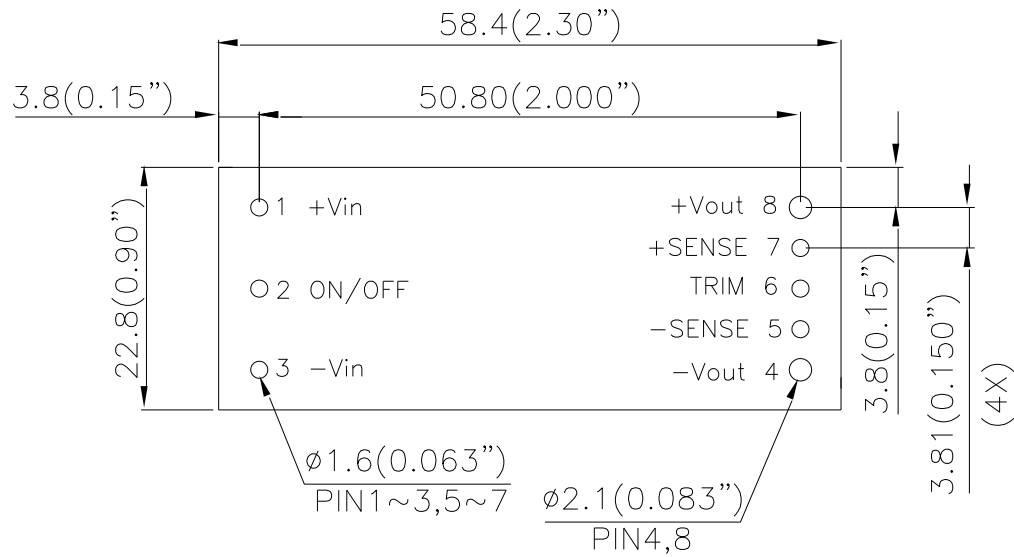
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)

X.XXmm±0.25mm(X.XXX in.±0.010 in.)

Notes: All pins are copper alloy with matte tin plated over Nickel under-plating.

RECOMMENDED PAD LAYOUT (THROUGH-HOLE MODULE)



RECOMENDED P.W.B. PAD LAYOUT

NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: X.Xmm $\pm$ 0.5mm(X.XX in. $\pm$ 0.02 in.)

X.XXmm $\pm$ 0.25mm(X.XXX in. $\pm$ 0.010 in.)

PART NUMBERING SYSTEM

E	48	S	H	120	13	N	R	F	A
Type of Product	Input Voltage	Number of Outputs	Product Series	Output Voltage	Output Current	ON/OFF Logic	Pin Length/Type		Option Code
E- Eighth Brick	48-36V~75V	S- Single	H-50A series	120 - 12V	13 -13A	N- Negative	R- 0.170" N- 0.145" K- 0.110"	F- RoHS 6/6 (Lead Free)	A- Standard Functions H - With heatspreader

MODEL LIST

MODEL NAME	INPUT		OUTPUT		EFF @ 100% LOAD
E48SH12013NRFA	36V~75V	4.8A	12V	13A	93%

Default remote on/off logic is negative and pin length is 0.170"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales office.

**** For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.***

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<http://moschip.ru/get-element>

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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